High Efficiency, High Voltage 20mA Synchronous Step-Down Converter

FEATURES

- **Wide Input Voltage Range: Operation from 4.5V to 50V**
- **Overvoltage Lockout Provides Protection Up to 60V**
- **Internal High Side and Low Side Power Switches**
- **No Compensation Required**
- **20mA Output Current**
- **Low Dropout Operation: 100% Duty Cycle**
- **Low Quiescent Current: 12µA**
- Wide Output Voltage Range: 0.8V to V_{IN}
- 0.8V ±1% Feedback Voltage Reference
- Adjustable Peak Current Limit
- Internal and External Soft-Start
- Precise RUN Pin Threshold with Adjustable Hysteresis
- Few External Components Required
- Low Profile (0.75mm) 3mm × 3mm DFN and Thermally Enhanced MS8E Packages

APPLICATIONS

- 4mA to 20mA Current Loops
- Industrial Control Supplies
- Distributed Power Systems
- Portable Instruments
- Battery-Operated Devices
- Automotive Power Systems

DESCRIPTION

The LTC®3632 is a high efficiency, high voltage step-down DC/DC converter with internal high side and synchronous power switches that draws only 12µA typical DC supply current at no load while maintaining output voltage regulation.

The LTC3632 can supply up to 20mA load current and features a programmable peak current limit that provides a simple method for optimizing efficiency in lower current applications. The LTC3632's combination of Burst Mode® operation, integrated power switches, low quiescent current, and programmable peak current limit provides high efficiency over a broad range of load currents.

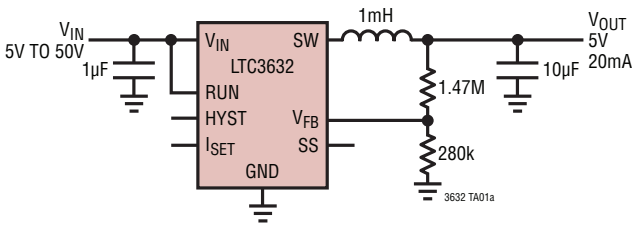
With its wide 4.5V to 50V input range and internal overvoltage monitor capable of protecting the part through 60V surges, the LTC3632 is a robust converter suited for regulating a wide variety of power sources. Additionally, the LTC3632 includes a precise run threshold and soft-start feature to guarantee that the power system start-up is well-controlled in any environment.

The LTC3632 is available in the thermally enhanced 3mm × 3mm DFN and MS8E packages.

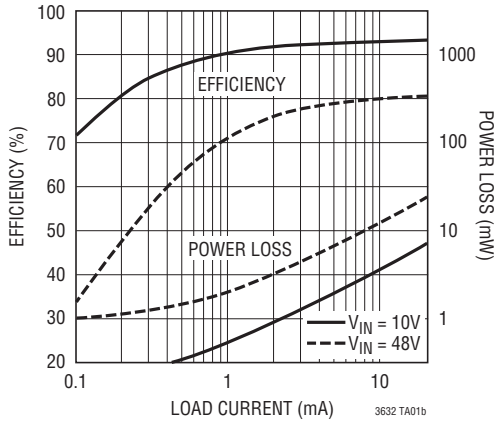
LT, LTC, LTM, Burst Mode, Linear Technology and the Linear logo are registered trademarks and ThinSOT is a trademark of Linear Technology Corporation. All other trademarks are the property of their respective owners.

TYPICAL APPLICATION

5V, 20mA Step-Down Converter



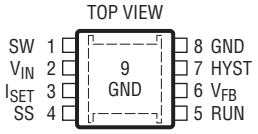
Efficiency and Power Loss vs Load Current



ABSOLUTE MAXIMUM RATINGS (Note 1)

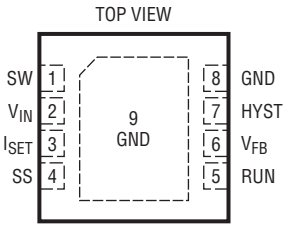
V_{IN} Supply Voltage ..... –0.3V to 60V
SW Voltage (DC) .....–0.3V to (V_{IN} + 0.3V)
RUN Voltage ..... –0.3V to 60V
V_{FB}, HYST, I_{SET}, SS Voltages..... –0.3V to 6V
Operating Junction Temperature Range
(Note 2)..... –40°C to 125°C
Storage Temperature Range..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec)
MS8E ..... 300°C

PIN CONFIGURATION



MS8E PACKAGE
8-LEAD PLASTIC MSOP

T_{JMAX} = 125°C, θ_{JA} = 40°C/W, θ_{JC} = 5°-10°C/W
EXPOSED PAD (PIN 9) IS GND, MUST BE SOLDERED TO PCB



DD PACKAGE
8-LEAD (3mm × 3mm) PLASTIC DFN

T_{JMAX} = 125°C, θ_{JA} = 43°C/W, θ_{JC} = 3°C/W
EXPOSED PAD (PIN 9) IS GND, MUST BE SOLDERED TO PCB

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC3632EMS8E#PBF	LTC3632EMS8E#TRPBF	LTFFZ	8-Lead Plastic MSOP	–40°C to 125°C
LTC3632IMS8E#PBF	LTC3632IMS8E#TRPBF	LTFFZ	8-Lead Plastic MSOP	–40°C to 125°C
LTC3632EDD#PBF	LTC3632EDD#TRPBF	LFGB	8-Lead (3mm × 3mm) Plastic DFN	–40°C to 125°C
LTC3632IDD#PBF	LTC3632IDD#TRPBF	LFGB	8-Lead (3mm × 3mm) Plastic DFN	–40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.
Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating junction temperature range, otherwise specifications are for T_A = 25°C (Note 2). V_{IN} = 10V, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Input Supply (V_{IN})							
V_{IN}	Input Voltage Operating Range			4.5		50	V
UVLO	V_{IN} Undervoltage Lockout	V_{IN} Rising V_{IN} Falling Hysteresis	● ●	3.80 3.75	4.15 4.00 150	4.50 4.35	V V mV
OVLO	V_{IN} Overvoltage Lockout	V_{IN} Rising V_{IN} Falling Hysteresis		54 52	56 54 2	59 57	V V V
I_Q	DC Supply Current (Note 3) Active Mode Sleep Mode Shutdown Mode	 V_{RUN} = 0V			 125 12 3	 220 22 6	 µA µA µA
Output Supply (V_{FB})							
V_{FB}	Feedback Comparator Trip Voltage	V_{FB} Rising	●	0.792	0.800	0.808	V
V_{HYST}	Feedback Comparator Hysteresis Voltage		●	3	5	7	mV
I_{FB}	Feedback Pin Current	V_{FB} = 1V		–10	0	10	nA
$\Delta V_{LINEREG}$	Feedback Voltage Line Regulation	V_{IN} = 4.5V to 50V			0.001		%/V
Operation							
V_{RUN}	RUN Pin Threshold Voltage	RUN Rising RUN Falling Hysteresis		1.17 1.06	1.21 1.10 110	1.25 1.14	V V mV
I_{RUN}	RUN Pin Leakage Current	RUN = 1.3V		–10	0	10	nA
V_{HYSTL}	Hysteresis Pin Voltage Low	RUN < 1V, I_{HYST} = 1mA			0.07	0.1	V
I_{HYST}	Hysteresis Pin Leakage Current	V_{HYST} = 1.3V		–10	0	10	nA
I_{SS}	Soft-Start Pin Pull-Up Current	V_{SS} < 1.5V		4.5	5.5	6.5	µA
t_{INTSS}	Internal Soft-Start Time	SS Pin Floating			0.75		ms
I_{PEAK}	Peak Current Trip Threshold	I_{SET} Floating 500k Resistor from I_{SET} to GND I_{SET} Shorted to GND	●	40 8	50 25 10	60 13	mA mA mA
R_{ON}	Power Switch On-Resistance Top Switch Bottom Switch	 I_{SW} = –10mA I_{SW} = 10mA			 5.0 2.5		 Ω Ω

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTC3632 is tested under pulsed load conditions such that $T_J \approx T_A$. LTC3632E is guaranteed to meet specifications from 0°C to 85°C junction temperature. Specifications over the –40°C to 125°C operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LTC3632I is guaranteed over the full –40°C to 125°C operating junction temperature range. Note that the maximum ambient temperature consistent with these specifications is determined by specific operating conditions in conjunction with board layout, the rated package thermal impedance and other environmental factors. The junction temperature (T_J, in °C) is calculated from the ambient temperature (T_A, in °C) and power dissipation (P_D, in Watts) according to the formula:

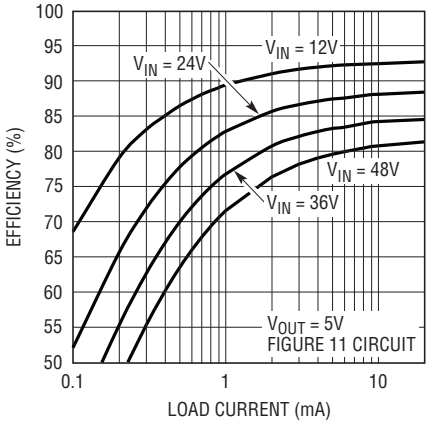
$T_J = T_A + (P_D \bullet \theta_{JA})$, where θ_{JA} (in °C/W) is the package thermal impedance.

Note 3: Dynamic supply current is higher due to the gate charge being delivered at the switching frequency. See Applications Information.

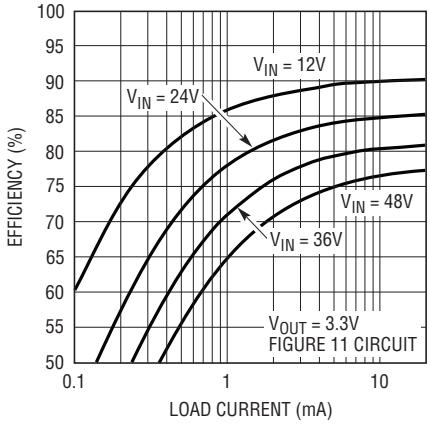
TYPICAL PERFORMANCE CHARACTERISTICS

T_A = 25°C, unless otherwise noted.

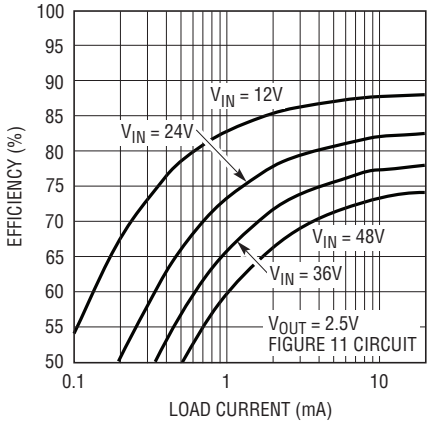
Efficiency vs Load Current, V_{OUT} = 5V



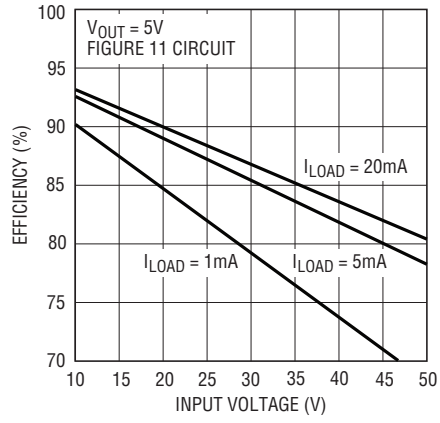
Efficiency vs Load Current, V_{OUT} = 3.3V



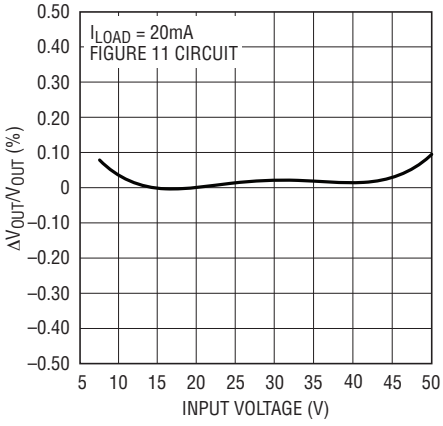
Efficiency vs Load Current, V_{OUT} = 2.5V



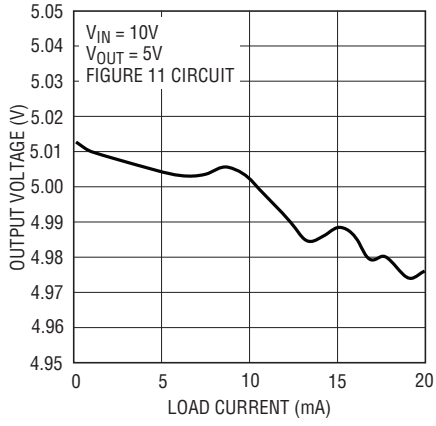
Efficiency vs Input Voltage



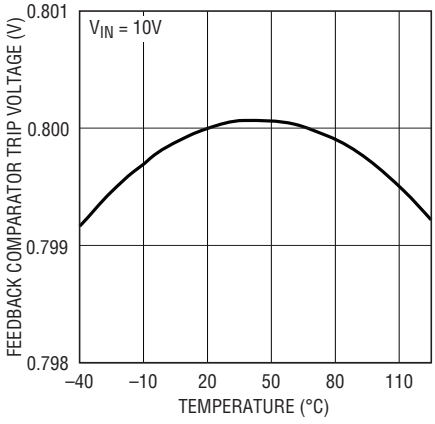
Line Regulation



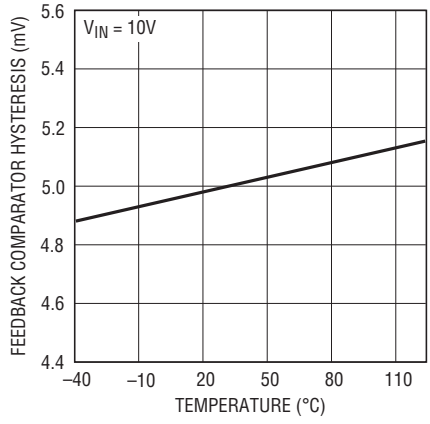
Load Regulation



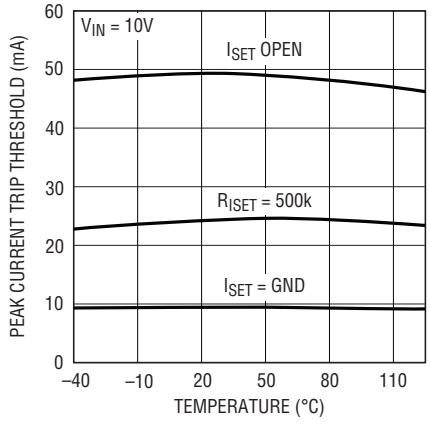
Feedback Comparator Trip Voltage vs Temperature



Feedback Comparator Hysteresis Voltage vs Temperature



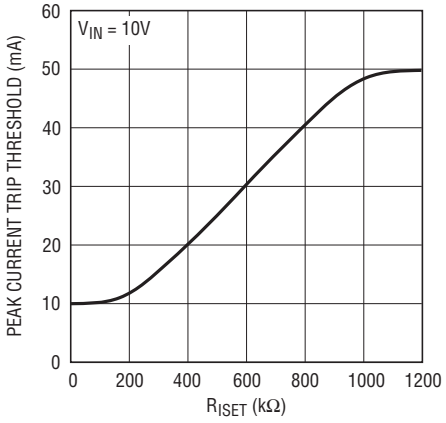
Peak Current Trip Threshold vs Temperature and I_{SET}



TYPICAL PERFORMANCE CHARACTERISTICS

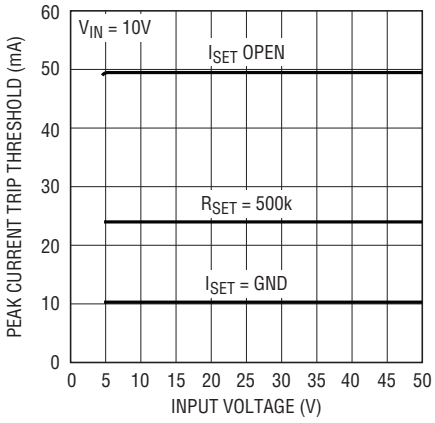
T_A = 25°C, unless otherwise noted.

Peak Current Trip Threshold vs R_{ISET}



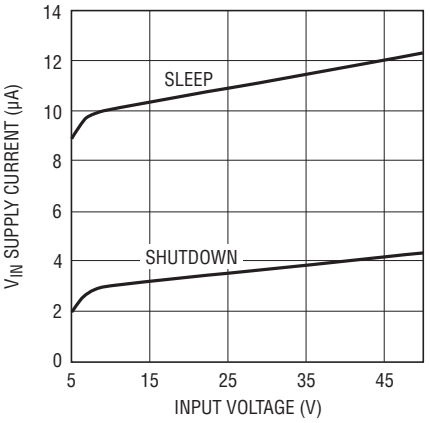
3632 G10

Peak Current Trip Threshold vs Input Voltage



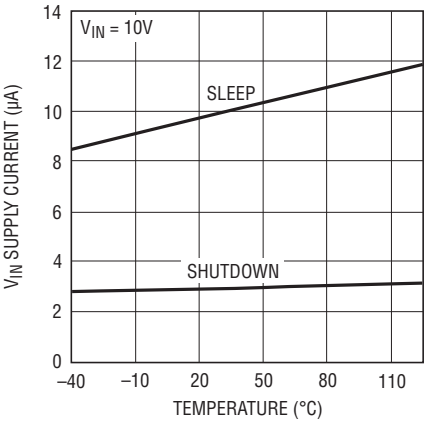
3632 G11

Quiescent Supply Current vs Input Voltage



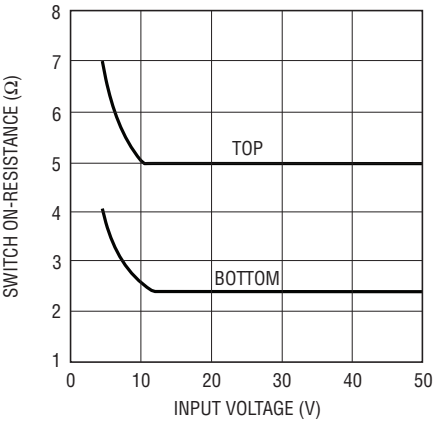
3632 G12

Quiescent Supply Current vs Temperature



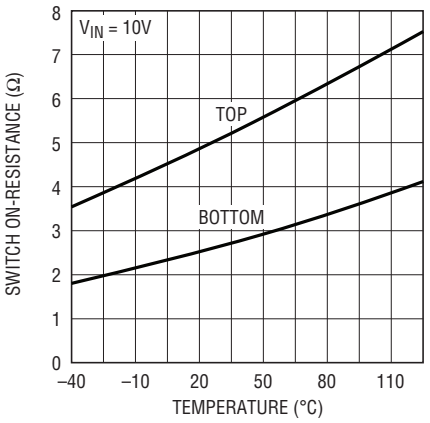
3632 G13

Switch On-Resistance vs Input Voltage



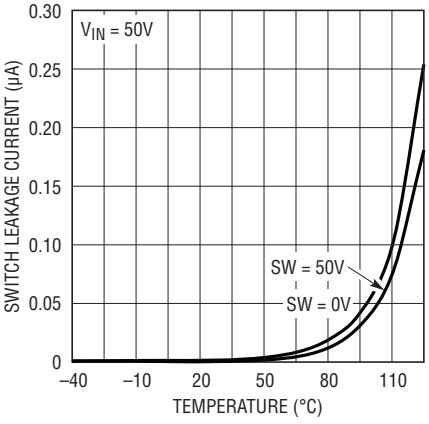
3632 G14

Switch On-Resistance vs Temperature



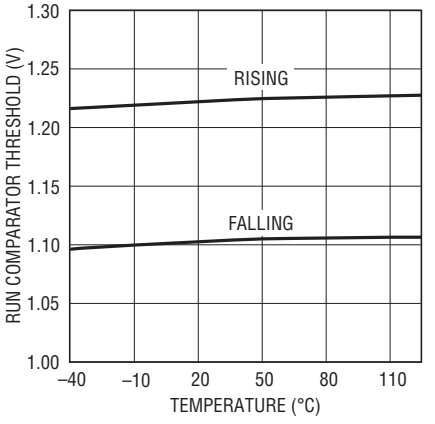
3632 G15

Switch Leakage Current vs Temperature



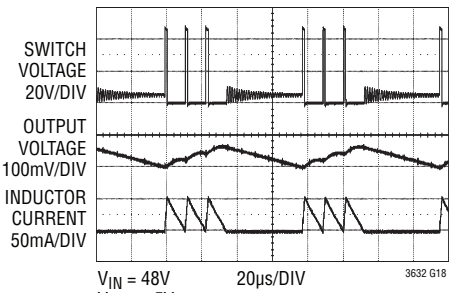
3632 G16

RUN Comparator Threshold Voltage vs Temperature



3632 G17

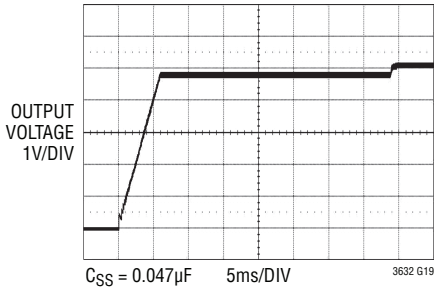
Operating Waveforms



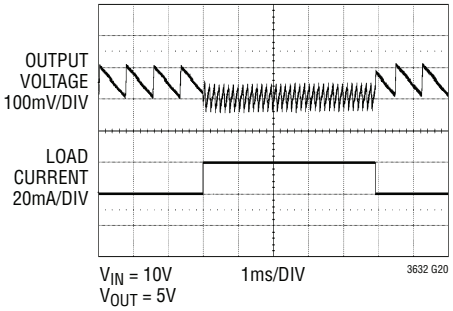
3632 G18

TYPICAL PERFORMANCE CHARACTERISTICS

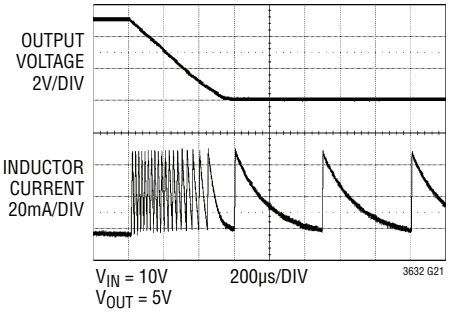
Soft-Start Waveforms



Load Step Transient Response



Short-Circuit Response



PIN FUNCTIONS

SW (Pin 1): Switch Node Connection to Inductor. This pin connects to the drains of the internal power MOSFET switches.

V_{IN} (Pin 2): Main Supply Pin. A ceramic bypass capacitor should be tied between this pin and GND (Pin 8).

I_{SET} (Pin 3): Peak Current Set Input. A resistor from this pin to ground sets the peak current trip threshold. Leave floating for the maximum peak current (50mA). Short this pin to ground for the minimum peak current (10mA). A 1µA current is sourced out of this pin.

SS (Pin 4): Soft-Start Control Input. A capacitor to ground at this pin sets the ramp time to full current output during start-up. A 5.5µA current is sourced out of this pin. If left floating, the ramp time defaults to an internal 0.75ms soft-start.

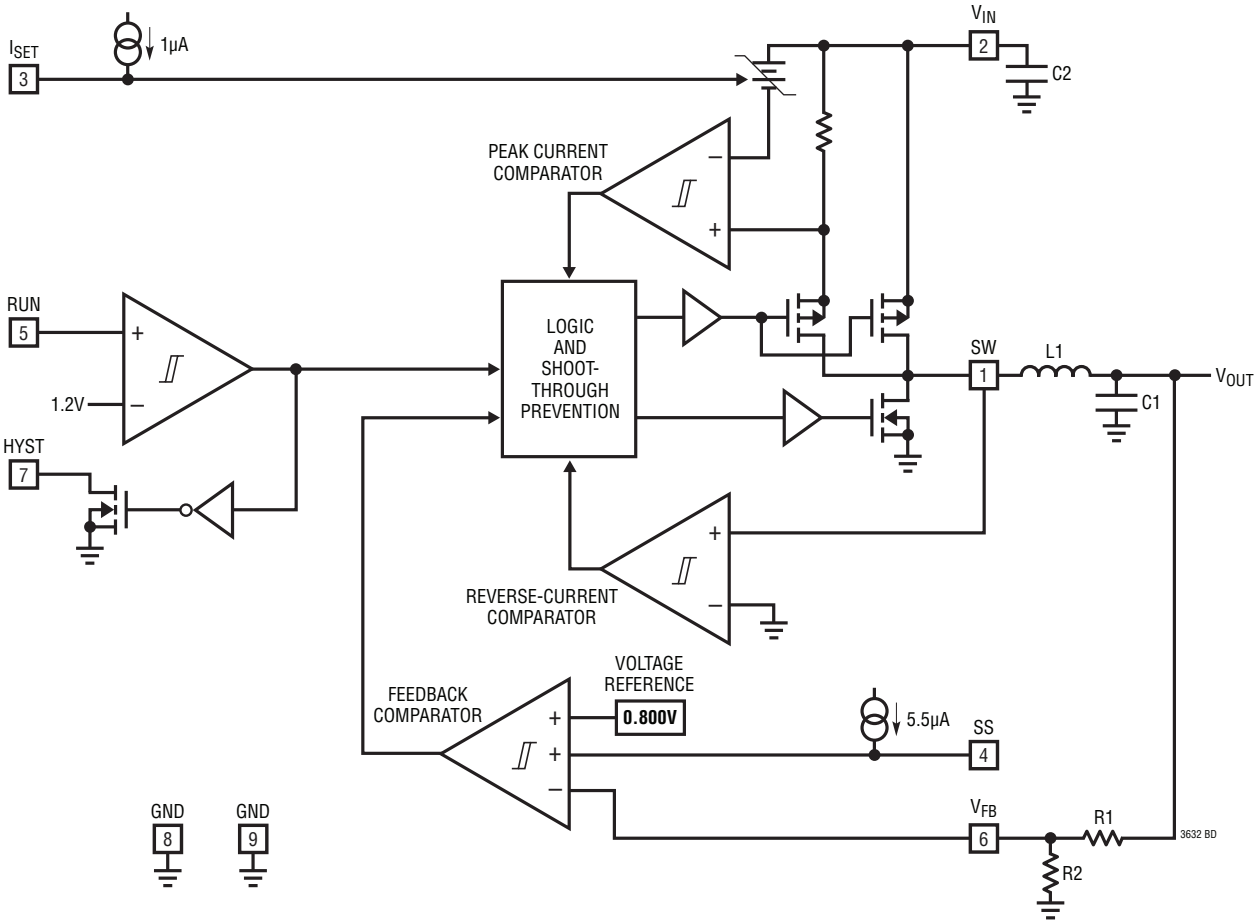
RUN (Pin 5): Run Control Input. A voltage on this pin above 1.2V enables normal operation. Forcing this pin below 0.7V shuts down the LTC3632, reducing quiescent current to approximately 3µA.

V_{FB} (Pin 6): Output Voltage Feedback. Connect to an external resistive divider to divide the output voltage down for comparison to the 0.8V reference.

HYST (Pin 7): Run Hysteresis Open-Drain Logic Output. This pin is pulled to ground when RUN (Pin 5) is below 1.2V. This pin can be used to adjust the RUN pin hysteresis. See Applications Information.

GND (Pin 8, Exposed Pad Pin 9): Ground. The exposed pad must be soldered to the printed circuit board ground plane for optimal electrical and thermal performance.

BLOCK DIAGRAM



OPERATION (Refer to Block Diagram)

The LTC3632 is a step-down DC/DC converter with internal power switches that uses Burst Mode control, combining low quiescent current with high switching frequency, which results in high efficiency across a wide range of load currents. Burst Mode operation functions by using short "burst" cycles to ramp the inductor current through the internal power switches, followed by a sleep cycle where the power switches are off and the load current is supplied by the output capacitor. During the sleep cycle, the LTC3632 draws only 12µA of supply current. At light loads, the burst cycles are a small percentage of the total cycle time which minimizes the average supply current, greatly improving efficiency.

Main Control Loop

The feedback comparator monitors the voltage on the V_{FB} pin and compares it to an internal 800mV reference. If this voltage is greater than the reference, the comparator activates a sleep mode in which the power switches and current comparators are disabled, reducing the V_{IN} pin supply current to only 12µA. As the load current discharges the output capacitor, the voltage on the V_{FB} pin decreases. When this voltage falls 5mV below the 800mV reference, the feedback comparator trips and enables burst cycles.

At the beginning of the burst cycle, the internal high side power switch (P-channel MOSFET) is turned on and the inductor current begins to ramp up. The inductor current increases until either the current exceeds the peak current comparator threshold or the voltage on the V_{FB} pin exceeds 800mV, at which time the high side power switch is turned off and the low side power switch (N-channel MOSFET) turns on. The inductor current ramps down until the reverse-current comparator trips, signaling that the current is close to zero. If the voltage on the V_{FB} pin is still less than the 800mV reference, the high side power switch is turned on again and another cycle commences. The average current during a burst cycle will normally be greater than the average load current. For this architecture, the maximum average output current is equal to half of the peak current.

The hysteretic nature of this control architecture results in a switching frequency that is a function of the input voltage, output voltage and inductor value. This behavior provides inherent short-circuit protection. If the output is shorted to ground, the inductor current will decay very slowly during a single switching cycle. Since the high side switch turns on only when the inductor current is near zero, the LTC3632 inherently switches at a lower frequency during start-up or short-circuit conditions.

Start-Up and Shutdown

If the voltage on the RUN pin is less than 0.7V, the LTC3632 enters a shutdown mode in which all internal circuitry is disabled, reducing the DC supply current to 3µA. When the voltage on the RUN pin exceeds 1.2V, normal operation of the main control loop is enabled. The RUN pin comparator has 110mV of internal hysteresis, and therefore must fall below 1.1V to disable the main control loop.

The HYST pin provides an added degree of flexibility for the RUN pin operation. This open-drain output is pulled to ground whenever the RUN comparator is not tripped, signaling that the LTC3632 is not in normal operation. In applications where the RUN pin is used to monitor the V_{IN} voltage through an external resistive divider, the HYST pin can be used to increase the effective RUN comparator hysteresis.

An internal 0.75ms soft-start function limits the ramp rate of the output voltage on start-up to prevent excessive input supply droop. If a longer ramp time and consequently less supply droop is desired, a capacitor can be placed from the SS pin to ground. The 5µA current that is sourced out of this pin will create a smooth voltage ramp on the capacitor. If this ramp rate is slower than the internal 0.75ms soft-start, then the output voltage will be limited by the ramp rate

OPERATION (Refer to Block Diagram)

on the SS pin instead. The internal and external soft-start functions are reset on start-up and after an undervoltage or overvoltage event on the input supply.

In order to ensure a smooth start-up transition in any application, the internal soft-start also ramps the peak inductor current from 10mA during its 0.75ms ramp time to the set peak current threshold. The external ramp on the SS pin does not limit the peak inductor current during start-up; however, placing a capacitor from the I_{SET} pin to ground does provide this capability.

Peak Inductor Current Programming

The offset of the peak current comparator nominally provides a peak inductor current of 50mA. This peak inductor current can be adjusted by placing a resistor from the I_{SET} pin to ground. The 1µA current sourced out of this pin through the resistor generates a voltage that is translated into an offset in the peak current comparator, which limits the peak inductor current.

Input Undervoltage and Overvoltage Lockout

The LTC3632 implements a protection feature which disables switching when the input voltage is not within the 4.5V to 50V operating range. If V_{IN} falls below 4V typical (4.35V maximum), an undervoltage detector disables switching. Similarly, if V_{IN} rises above 55V typical (53V minimum), an overvoltage detector disables switching. When switching is disabled, the LTC3632 can safely sustain input voltages up to the absolute maximum rating of 60V. Switching is enabled when the input voltage returns to the 4.5V to 50V operating range.

APPLICATIONS INFORMATION

The basic LTC3632 application circuit is shown on the front page of this data sheet. External component selection is determined by the maximum load current requirement and begins with the selection of the peak current programming resistor, R_{ISET}. The inductor value L can then be determined, followed by capacitors C_{IN} and C_{OUT}.

Peak Current Resistor Selection

The peak current comparator has a maximum current limit of 50mA nominally, which results in a maximum average current of 25mA. For applications that demand less current, the peak current threshold can be reduced to as little as 10mA. This lower peak current allows the use of lower value, smaller components (input capacitor, output capacitor and inductor), resulting in lower input supply ripple and a smaller overall DC/DC converter.

The threshold can be easily programmed with an appropriately chosen resistor (R_{ISET}) between the I_{SET} pin and ground. The value of resistor for a particular peak current can be computed by using Figure 1 or the following equation:

$$R_{ISET} = I_{PEAK} \bullet 21 \bullet 10^6$$

where $10mA < I_{PEAK} < 50mA$.

The peak current is internally limited to be within the range of 10mA to 50mA. Shorting the I_{SET} pin to ground programs the current limit to 10mA, and leaving it floating sets the current limit to the maximum value of 50mA. When selecting this resistor value, be aware that the maximum average output current for this architecture is limited to half of the peak current. Therefore, be sure to select a value that sets the peak current with enough margin to provide adequate load current under all foreseeable operating conditions.

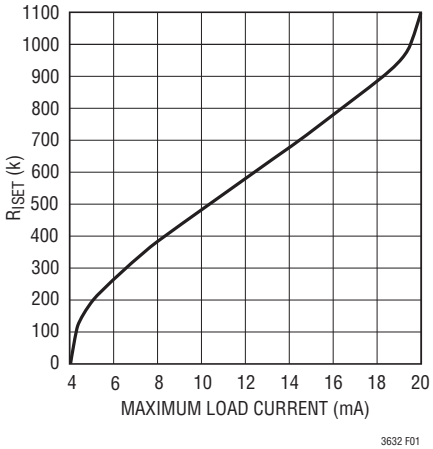


Figure 1. R_{ISET} Selection

Inductor Selection

The inductor, input voltage, output voltage and peak current determine the switching frequency of the LTC3632. For a given input voltage, output voltage and peak current, the inductor value sets the switching frequency when the output is in regulation. A good first choice for the inductor value can be determined by the following equation:

$$L = \left(\frac{V_{OUT}}{f \bullet I_{PEAK}}\right) \bullet \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

The variation in switching frequency with input voltage and inductance is shown in the following two figures for typical values of V_{OUT}. For lower values of I_{PEAK}, multiply the frequency in Figure 2 and Figure 3 by $50mA/I_{PEAK}$.

An additional constraint on the inductor value is the LTC3632's 100ns minimum on-time of the high side switch. Therefore, in order to keep the current in the inductor well controlled, the inductor value must be chosen so that it is larger than L_{MIN}, which can be computed as follows:

$$L_{MIN} = \frac{V_{IN(MAX)} \bullet t_{ON(MIN)}}{I_{PEAK(MAX)}}$$

where $V_{IN(MAX)}$ is the maximum input supply voltage for the application, $t_{ON(MIN)}$ is 100ns, and $I_{PEAK(MAX)}$ is the maximum allowed peak inductor current. Although the above equation provides the minimum inductor value, higher efficiency is generally achieved with a larger inductor value, which produces a lower switching frequency. For a given inductor type, however, as inductance is increased DC resistance (DCR) also increases. Higher DCR translates into higher copper losses and lower current rating, both of which place an upper limit on the inductance. The recommended range of inductor values for small surface mount inductors as a function of peak current is shown in Figure 4. The values in this range are a good compromise between the trade-offs discussed above. For applications

APPLICATIONS INFORMATION

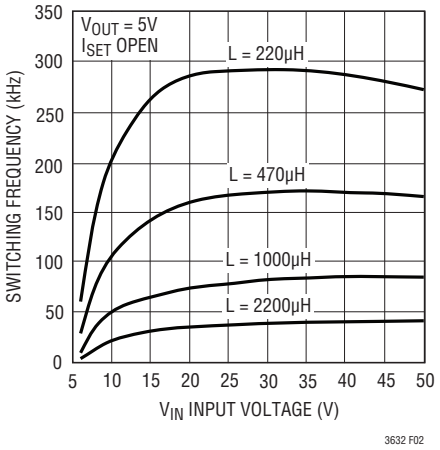


Figure 2. Switching Frequency for V_{OUT} = 5V

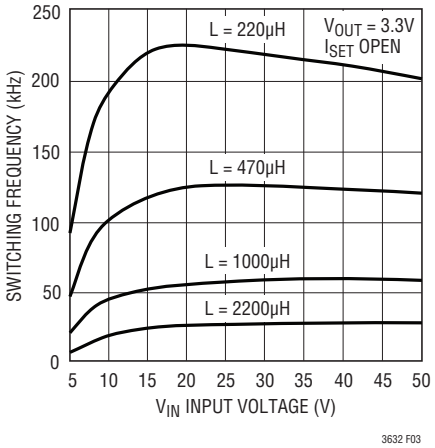


Figure 3. Switching Frequency for V_{OUT} = 3.3V

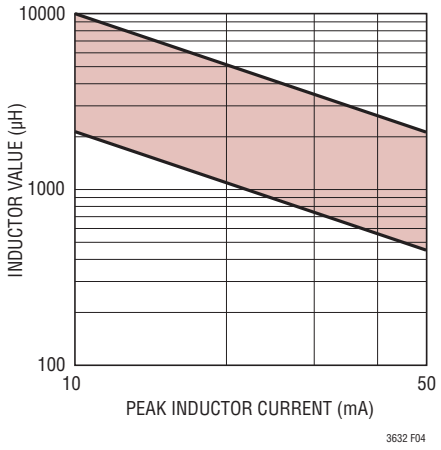


Figure 4. Recommended Inductor Values for Maximum Efficiency

where board area is not a limiting factor, inductors with larger cores can be used, which extends the recommended range of Figure 4 to larger values.

Inductor Core Selection

Once the value for L is known, the type of inductor must be selected. High efficiency converters generally cannot afford the core loss found in low cost powdered iron cores, forcing the use of the more expensive ferrite cores. Actual core loss is independent of core size for a fixed inductor value but is very dependent of the inductance selected. As the inductance increases, core losses decrease. Unfortunately, increased inductance requires more turns of wire and therefore copper losses will increase.

Ferrite designs have very low core losses and are preferred at high switching frequencies, so design goals can concentrate on copper loss and preventing saturation. Ferrite core material saturates "hard," which means that inductance collapses abruptly when the peak design current is exceeded. This results in an abrupt increase in inductor ripple current and consequently output voltage ripple. Do not allow the core to saturate!

Different core materials and shapes will change the size/current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or permalloy materials are small and do not radiate energy but generally cost more than powdered iron core inductors with similar characteristics. The choice of which style inductor to use mainly depends on the price vs size requirements and any radiated field/EMI requirements. New designs for surface mount inductors are available from Coiltronics, Coilcraft, TDK, Toko, Sumida and Vishay.

C_{IN} and C_{OUT} Selection

The input capacitor, C_{IN}, is needed to filter the trapezoidal current at the source of the top high side MOSFET. To prevent large ripple voltage, a low ESR input capacitor sized for the maximum RMS current should be used. Approximate RMS current is given by:

$$I_{RMS} = I_{OUT(MAX)} \bullet \frac{V_{OUT}}{V_{IN}} \bullet \sqrt{\frac{V_{IN}}{V_{OUT}} - 1}$$

APPLICATIONS INFORMATION

This formula has a maximum at $V_{IN} = 2V_{OUT}$, where $I_{RMS} = I_{OUT}/2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that ripple current ratings from capacitor manufacturers are often based only on 2000 hours of life which makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Several capacitors may also be paralleled to meet size or height requirements in the design.

The output capacitor, C_{OUT}, filters the inductor's ripple current and stores energy to satisfy the load current when the LTC3632 is in sleep. The output voltage ripple during a burst cycle is dominated by the output capacitor equivalent series resistance (ESR) and can be estimated by the following equation:

$$\frac{V_{OUT}}{160} < \Delta V_{OUT} \leq I_{PEAK} \bullet ESR$$

where the lower limit of $V_{OUT}/160$ is due to the 5mV feedback comparator hysteresis.

The value of the output capacitor must be large enough to accept the energy stored in the inductor without a large change in output voltage. Setting this voltage step equal to 1% of the output voltage, the output capacitor must be:

$$C_{OUT} > 50 \bullet L \bullet \left(\frac{I_{PEAK}}{V_{OUT}}\right)^2$$

Typically, a capacitor that satisfies the ESR requirement is adequate to filter the inductor ripple. To avoid overheating, the output capacitor must also be sized to handle the ripple current generated by the inductor. The worst-case ripple current in the output capacitor is given by $I_{RMS} = I_{PEAK}/2$. Multiple capacitors placed in parallel may be needed to meet the ESR and RMS current handling requirements.

Dry tantalum, special polymer, aluminum electrolytic, and ceramic capacitors are all available in surface mount packages. Special polymer capacitors offer very low ESR but have lower capacitance density than other types. Tantalum capacitors have the highest capacitance density but it is important only to use types that have been surge tested for use in switching power supplies. Aluminum electrolytic capacitors have significantly higher ESR but can be used in cost-sensitive applications provided that consideration is given to ripple current ratings and long-term reliability. Ceramic capacitors have excellent low ESR characteristics but can have high voltage coefficient and audible piezoelectric effects. The high quality factor (Q) of ceramic capacitors in series with trace inductance can also lead to significant ringing.

Using Ceramic Input and Output Capacitors

Higher value, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. However, care must be taken when these capacitors are used at the input and output. When a ceramic capacitor is used at the input and the power is supplied by a wall adapter through long wires, a load step at the output can induce ringing at the input, V_{IN}. At best, this ringing can couple to the output and be mistaken as loop instability. At worst, a sudden inrush of current through the long wires can potentially cause a voltage spike at V_{IN} large enough to damage the part.

For applications with inductive source impedance, such as a long wire, a series RC network may be required in parallel with C_{IN} to dampen the ringing of the input supply. Figure 5 shows this circuit and the typical values required to dampen the ringing.

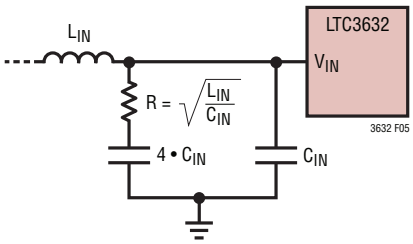


Figure 5. Series RC to Reduce V_{IN} Ringing

Output Voltage Programming

The output voltage is set by an external resistive divider according to the following equation:

$$V_{OUT} = 0.8V \bullet \left(1 + \frac{R1}{R2}\right)$$

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The resistive divider allows the V_{FB} pin to sense a fraction of the output voltage as shown in Figure 6. Output voltage adjustment range is from 0.8V to V_{IN}.

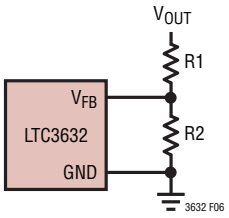


Figure 6. Setting the Output Voltage

To minimize the no-load supply current, resistor values in the megohm range should be used; however, large resistor values should be used with caution. The feedback divider is the only load current when in shutdown. If PCB leakage current to the output node or switch node exceeds the load current, the output voltage will be pulled up. In normal operation, this is generally a minor concern since the load current is much greater than the leakage. The increase in supply current due to the feedback resistors can be calculated from:

$$\Delta I_{VIN} = \left(\frac{V_{OUT}}{R1+R2}\right) \bullet \left(\frac{V_{OUT}}{V_{IN}}\right)$$

Run Pin with Programmable Hysteresis

The LTC3632 has a low power shutdown mode controlled by the RUN pin. Pulling the RUN pin below 0.7V puts the LTC3632 into a low quiescent current shutdown mode (I_Q ~ 3µA). When the RUN pin is greater than 1.2V, the controller is enabled. Figure 7 shows examples of configurations for driving the RUN pin from logic.

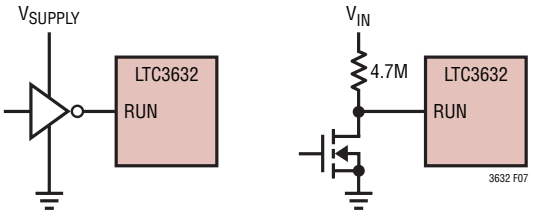


Figure 7. RUN Pin Interface to Logic

The RUN pin can alternatively be configured as a precise undervoltage lockout (UVLO) on the V_{IN} supply with a resistive divider from V_{IN} to ground. The RUN pin comparator nominally provides 10% hysteresis when used in this method; however, additional hysteresis may be added with the use of the HYST pin. The HYST pin is an open-drain output that is pulled to ground whenever the RUN comparator is not tripped. A simple resistive divider can be used as shown in Figure 8 to meet specific V_{IN} voltage requirements.

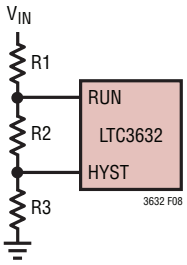


Figure 8. Adjustable Undervoltage Lockout

Specific values for these UVLO thresholds can be computed from the following equations:

$$\text{Rising } V_{IN} \text{ UVLO Threshold} = 1.21V \bullet \left(1+\frac{R1}{R2}\right)$$

$$\text{Falling } V_{IN} \text{ UVLO Threshold} = 1.10V \bullet \left(1+\frac{R1}{R2+R3}\right)$$

The minimum value of these thresholds is limited to the internal V_{IN} UVLO thresholds that are shown in the Electrical Characteristics table. The current that flows through this divider will directly add to the shutdown, sleep and active current of the LTC3632, and care should be taken to minimize the impact of this current on the overall efficiency of the application circuit. Resistor values in the megohm range may be required to keep the impact on quiescent shutdown and sleep currents low. Be aware that the HYST pin cannot be allowed to exceed its absolute maximum

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rating of 6V. To keep the voltage on the HYST pin from exceeding 6V, the following relation should be satisfied:

$$V_{IN(MAX)} \bullet \left(\frac{R3}{R1+R2+R3} \right) < 6V$$

The RUN pin may also be directly tied to the V_{IN} supply for applications that do not require the programmable undervoltage lockout feature. In this configuration, switching is enabled when V_{IN} surpasses the internal undervoltage lockout threshold.

Soft-Start

The internal 0.75ms soft-start is implemented by ramping both the effective reference voltage from 0V to 0.8V and the peak current limit set by the I_{SET} pin (10mA to 50mA).

To increase the duration of the reference voltage soft-start, place a capacitor from the SS pin to ground. An internal 5µA pull-up current will charge this capacitor, resulting in a soft-start ramp time given by:

$$t_{SS} = C_{SS} \bullet \frac{0.8V}{5\mu A}$$

When the LTC3632 detects a fault condition (input supply undervoltage or overvoltage) or when the RUN pin falls below 1.1V, the SS pin is quickly pulled to ground and the internal soft-start timer is reset. This ensures an orderly restart when using an external soft-start capacitor.

The duration of the 0.75ms internal peak current soft-start may be increased by placing a capacitor from the I_{SET} pin to ground. The peak current soft-start will ramp from 10mA to the final peak current value determined by a resistor from I_{SET} to ground. A 1µA current is sourced out of the I_{SET} pin. With only a capacitor connected between I_{SET} and ground, the peak current ramps linearly from 10mA to 50mA, and the peak current soft-start time can be expressed as:

$$t_{SS(ISET)} = C_{ISET} \bullet \frac{0.8V}{1\mu A}$$

A linear ramp of peak current appears as a quadratic waveform on the output voltage. For the case where the peak current is reduced by placing a resistor from I_{SET} to ground, the peak current offset ramps as a decaying exponential with a time constant of $R_{ISET} \bullet C_{ISET}$. For this case, the peak current soft-start time is approximately $3 \bullet R_{ISET} \bullet C_{ISET}$.

Unlike the SS pin, the I_{SET} pin does not get pulled to ground during an abnormal event; however, if the I_{SET} pin is floating (programmed to 50mA peak current), the SS and I_{SET} pins may be tied together and connected to a capacitor to ground. For this special case, both the peak current and the reference voltage will soft-start on power-up and after fault conditions. The ramp time for this combination is $C_{SS(ISET)} \bullet (0.8V/6\mu A)$.

Efficiency Considerations

The efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Efficiency can be expressed as:

Efficiency = 100% – (L1 + L2 + L3 + ...)

where L1, L2, etc. are the individual losses as a percentage of input power.

Although all dissipative elements in the circuit produce losses, two main sources usually account for most of the losses: V_{IN} operating current and I^2R losses. The V_{IN} operating current dominates the efficiency loss at very low load currents whereas the I^2R loss dominates the efficiency loss at medium to high load currents.

1. The V_{IN} operating current comprises two components: The DC supply current as given in the electrical characteristics and the internal MOSFET gate charge currents. The gate charge current results from switching the gate capacitance of the internal power MOSFET switches. Each time the gate is switched from high to low to high again, a packet of charge, dQ, moves from V_{IN} to ground. The resulting dQ/dt is the current out of V_{IN} that is typically larger than the DC bias current.

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2. I^2R losses are calculated from the resistances of the internal switches, R_{SW}, and external inductor R_L. When switching, the average output current flowing through the inductor is "chopped" between the high side PMOS switch and the low side NMOS switch. Thus, the series resistance looking back into the switch pin is a function of the top and bottom switch $R_{DS(ON)}$ values and the duty cycle (DC = V_{OUT}/V_{IN}) as follows:

$$R_{SW} = (R_{DS(ON)TOP})DC + (R_{DS(ON)BOT})(1 - DC)$$

The $R_{DS(ON)}$ for both the top and bottom MOSFETs can be obtained from the Typical Performance Characteristics curves. Thus, to obtain the I^2R losses, simply add R_{SW} to R_L and multiply the result by the square of the average output current:

$$I^2R \text{ Loss} = I_O^2(R_{SW} + R_L)$$

Other losses, including C_{IN} and C_{OUT} ESR dissipative losses and inductor core losses, generally account for less than 2% of the total power loss.

Thermal Considerations

The LTC3632 does not dissipate much heat due to its high efficiency and low peak current level. Even in worst-case conditions (high ambient temperature, maximum peak current and high duty cycle), the junction temperature will exceed ambient temperature by only a few degrees.

Design Example

As a design example, consider using the LTC3632 in an application with the following specifications: V_{IN} = 24V, V_{OUT} = 3.3V, I_{OUT} = 20mA, f = 250kHz. Furthermore, assume for this example that switching should start when V_{IN} is greater than 12V and should stop when V_{IN} is less than 8V.

First, calculate the inductor value that gives the required switching frequency:

$$L = \left(\frac{3.3V}{250kHz \bullet 50mA}\right) \bullet \left(1 - \frac{3.3V}{24V}\right) \cong 220\mu H$$

Next, verify that this value meets the L_{MIN} requirement. For this input voltage and peak current, the minimum inductor value is:

$$L_{MIN} = \frac{24V \bullet 100ns}{50mA} \cong 48\mu H$$

Therefore, the minimum inductor requirement is satisfied, and the 220µH inductor value may be used.

Next, C_{IN} and C_{OUT} are selected. For this design, C_{IN} should be size for a current rating of at least:

$$I_{RMS} = 20mA \bullet \frac{3.3V}{24V} \bullet \sqrt{\frac{24V}{3.3V} - 1} \cong 7mA_{RMS}$$

Due to the low peak current of the LTC3632, decoupling the V_{IN} supply with a 1µF capacitor is adequate for most applications.

C_{OUT} will be selected based on the ESR that is required to satisfy the output voltage ripple requirement. For a 50mV output ripple, the value of the output capacitor ESR can be calculated from:

$$\Delta V_{OUT} = 50mV \leq 50mA \bullet ESR$$

A capacitor with a 1Ω ESR satisfies this requirement. A 10µF ceramic capacitor has significantly less ESR than 1Ω.

The output voltage can now be programmed by choosing the values of R1 and R2. Choose R2 = 240k and calculate R1 as:

$$R1 = \left(\frac{V_{OUT}}{0.8V} - 1\right) \bullet R2 = 750k$$

The undervoltage lockout requirement on V_{IN} can be satisfied with a resistive divider from V_{IN} to the RUN and HYST pins. Choose R1 = 2M and calculate R2 and R3 as follows:

$$R2 = \left(\frac{1.21V}{V_{IN(RISING)} - 1.21V}\right) \bullet R1 = 224k$$

$$R3 = \left(\frac{1.1V}{V_{IN(FALLING)} - 1.1V}\right) \bullet R1 - R2 = 90.8k$$

APPLICATIONS INFORMATION

Choose standard values for R2 = 226k and R3 = 91k. The I_{SET} pin should be left open in this example to select maximum peak current (50mA). Figure 9 shows a complete schematic for this design example.

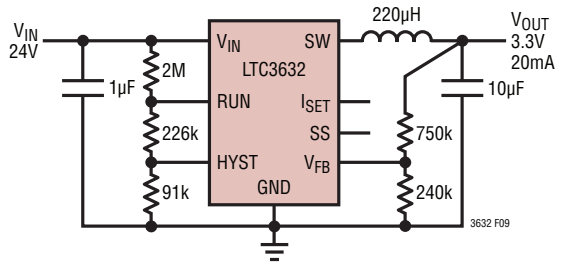
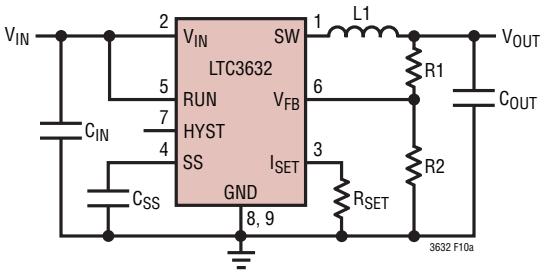


Figure 9. 24V to 3.3V, 20mA Regulator at 250kHz

PC Board Layout Checklist

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the LTC3632. Check the following in your layout:

1. Large switched currents flow in the power switches and input capacitor. The loop formed by these components should be as small as possible. A ground plane is recommended to minimize ground impedance.
2. Connect the (+) terminal of the input capacitor, C_{IN}, as close as possible to the V_{IN} pin. This capacitor provides the AC current into the internal power MOSFETs.
3. Keep the switching node, SW, away from all sensitive small-signal nodes. The rapid transitions on the switching node can couple to high impedance nodes, in particular V_{FB}, and create increased output ripple.
4. Flood all unused area on all layers with copper. Flooding with copper will reduce the temperature rise of power components. You can connect the copper areas to any DC net (V_{IN}, V_{OUT}, GND or any other DC rail in your system).



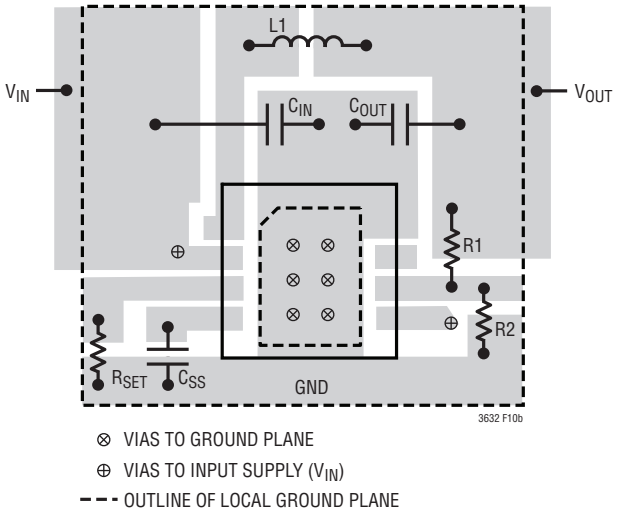
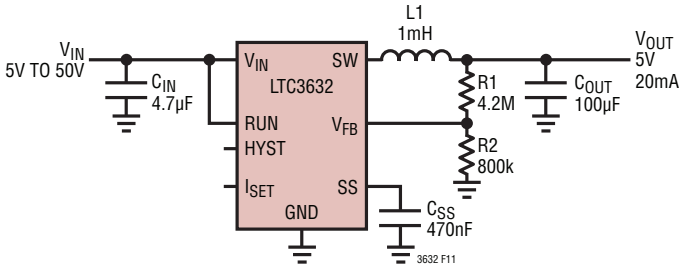


Figure 10. Layout Example

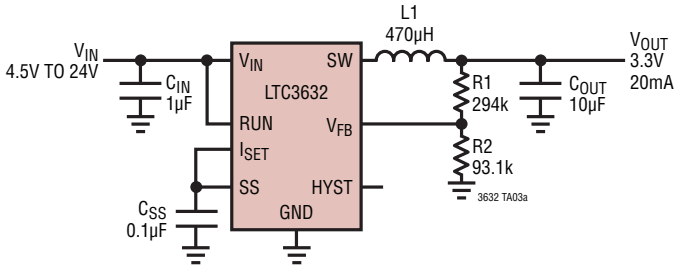
TYPICAL APPLICATIONS



C_{IN}: TDK C5750X7R2A475MT
C_{OUT}: AVX 1812D107MAT
L1: COILCRAFT LPS6235-105ML

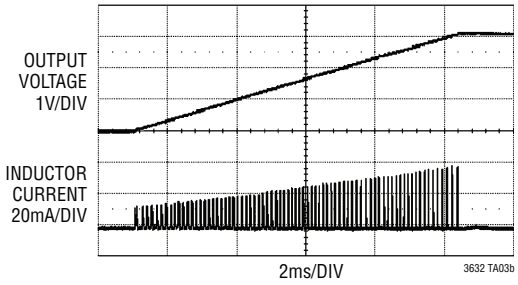
Figure 11. High Efficiency 5V Regulator

3.3V, 20mA Regulator with Peak Current Soft-Start, Small Size

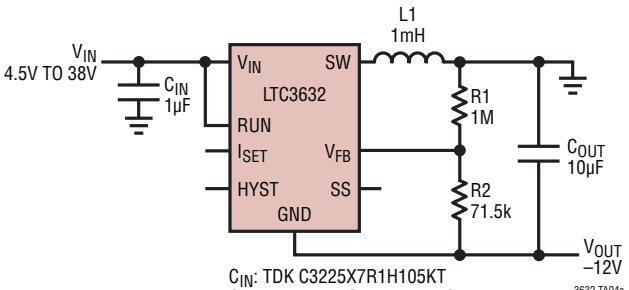


C_{IN}: TDK C3216X7R1E105KT
C_{OUT}: AVX 08056D106KAT2A
L1: MURATA LQH43CN471K03

Soft-Start Waveforms

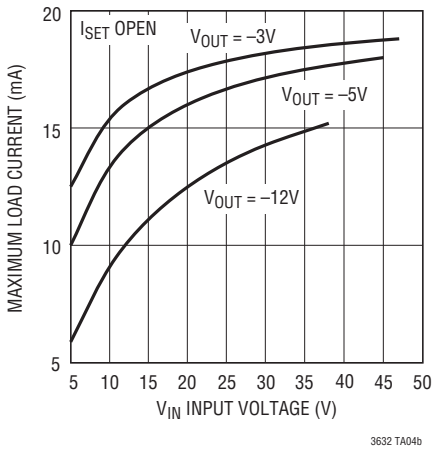


Positive-to-Negative Converter



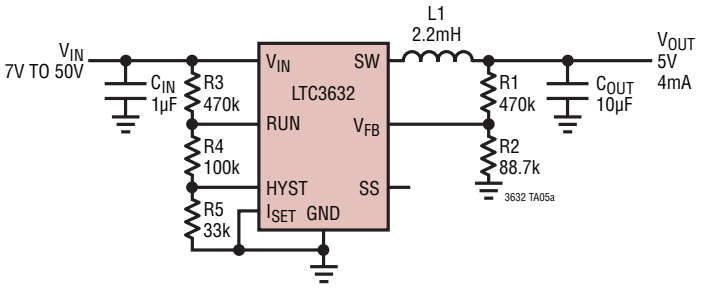
C_{IN}: TDK C3225X7R1H105KT
C_{OUT}: MURATA GRM32DR71C106KA01
L1: TYCO/COEV DQ6545-102M

Maximum Load Current vs Input Voltage



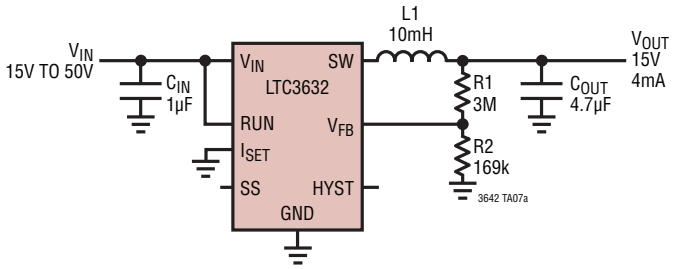
TYPICAL APPLICATIONS

Small Size, Limited Peak Current, 4mA Regulator



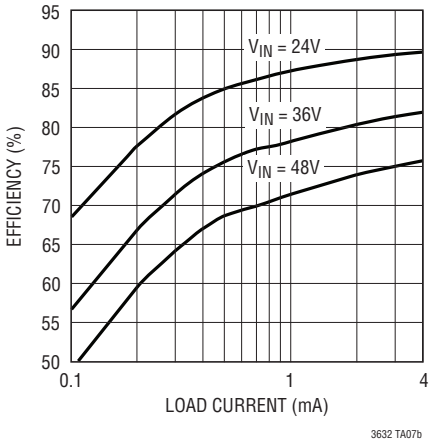
C_{IN}: TDK C3225X7R1H105KT
C_{OUT}: AVX 08056D106KAT2A
L1: MURATA LQH43NN222K03

High Efficiency 15V, 4mA Regulator



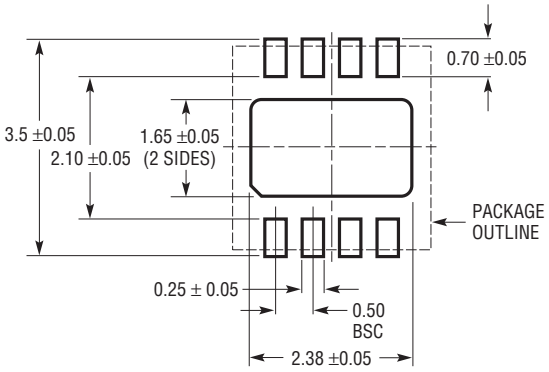
C_{IN}: AVX 18125C105KAT2A
C_{OUT}: TDK C3216X7R1E475KT
L1: COILCRAFT LPS6235-106ML

Efficiency vs Load Current

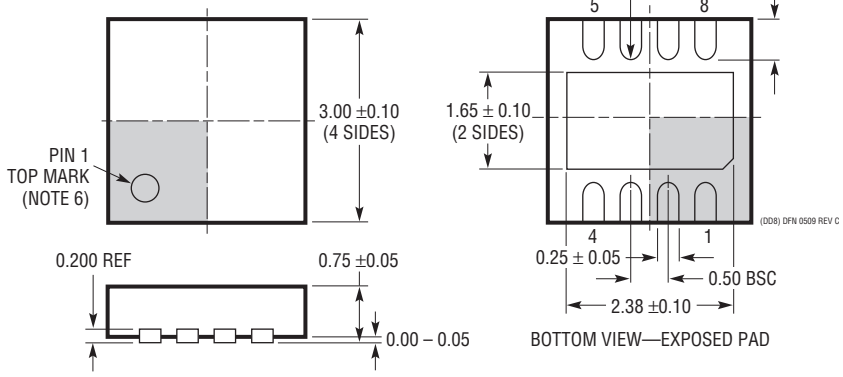


PACKAGE DESCRIPTION

DD Package
8-Lead Plastic DFN (3mm × 3mm)
(Reference LTC DWG # 05-08-1698 Rev C)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS
APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED

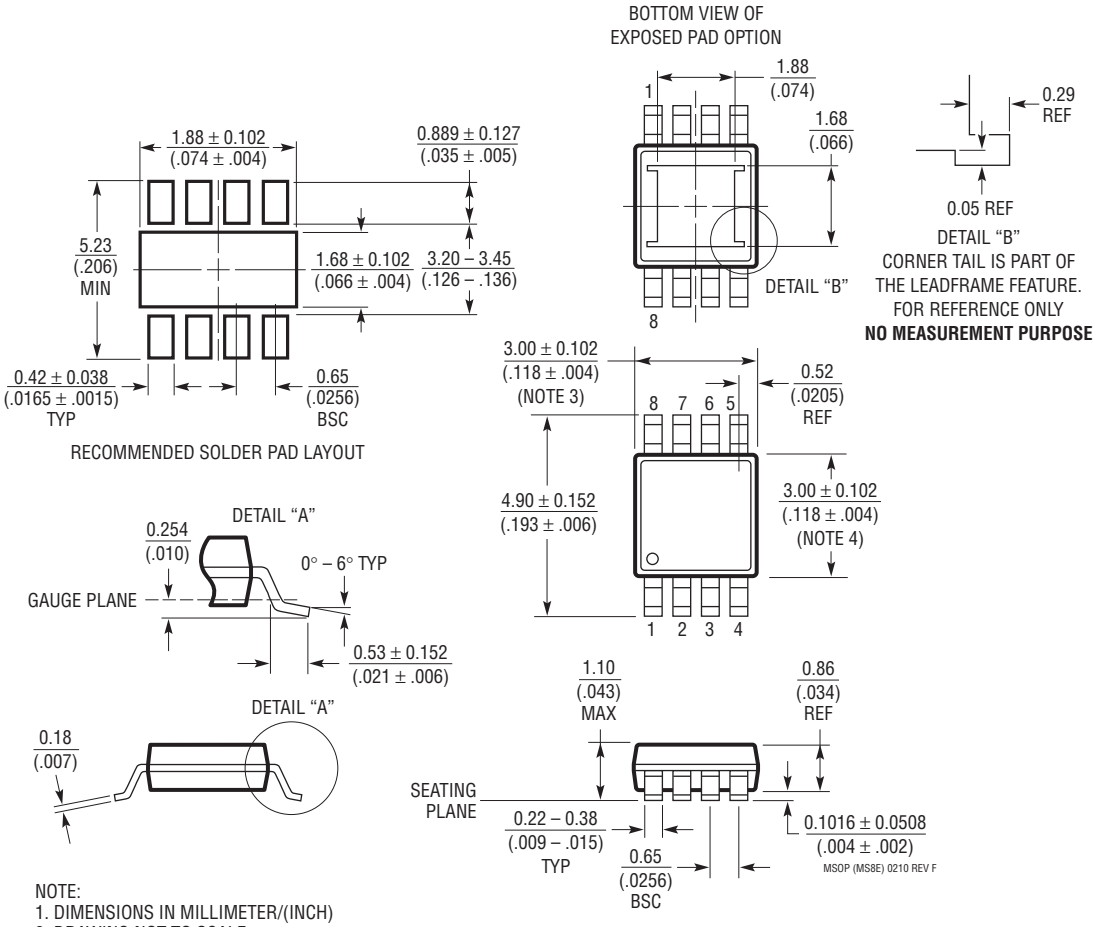


BOTTOM VIEW—EXPOSED PAD

NOTE:
1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WEED-1)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON TOP AND BOTTOM OF PACKAGE

PACKAGE DESCRIPTION

MS8E Package
8-Lead Plastic MSOP, Exposed Die Pad
(Reference LTC DWG # 05-08-1662 Rev F)



NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
   INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX
6. EXPOSED PAD DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH ON E-PAD
   SHALL NOT EXCEED 0.254mm (.010") PER SIDE.

REVISION HISTORY (Revision history begins at Rev B)

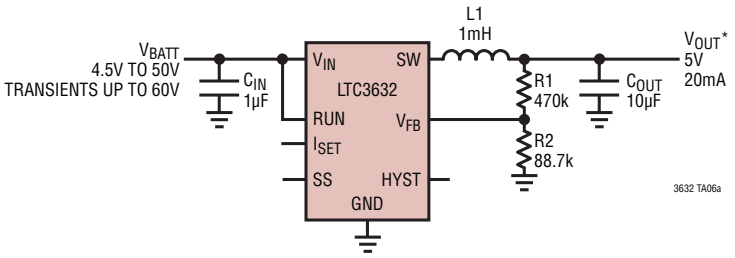
REV	DATE	DESCRIPTION	PAGE NUMBER
B	6/10	Text updates in Description	1
		Updates to Electrical Characteristics	3
		Updates to graphs G08, G09, G17, G18, G19	4, 5, 6
		Updated description for Pins 8 and 9 in Pin Functions	6
		Text updates in Operation section	8, 9
		Text updates in Applications Information section	13
		Figure 10 graphic added	16
		Asterisk and related text added to Typical Application	22
		Related Parts updated	22

LINEAR TECHNOLOGY

Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights.

TYPICAL APPLICATION

5V, 20mA Regulator for Automotive Applications



C_{IN}: TDK C3225X7R2A105M
C_{OUT}: KEMET C1210C106K4RAC
L1: COILTRONICS DRA73-102-R

*$V_{OUT} = V_{BATT}$ FOR $V_{BATT} < 5V$

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC3631/LTC3631-3.3/ LTC3631-5	45V, 100mA Synchronous Micropower Step-Down DC/DC Converter	V_{IN}: 4.5V to 45V (60V_{MAX}), $V_{OUT(MIN)}$ = 0.8V, I_Q = 12µA, I_{SD} = 3µA, 3mm × 3mm DFN8, MSOP8E
LTC3642/LTC3642-3.3/ LTC3642-5	45V, 50mA Synchronous Micropower Step-Down DC/DC Converter	V_{IN}: 4.5V to 45V (60V_{MAX}), $V_{OUT(MIN)}$ = 0.8V, I_Q = 12µA, I_{SD} = 3µA, 3mm × 3mm DFN8, MSOP8E
LTC1474	18V, 250mA (I_{OUT}), High Efficiency Step-Down DC/DC Converter	V_{IN}: 3V to 18V, $V_{OUT(MIN)}$ = 1.2V, I_Q = 10µA, I_{SD} = 6µA, MSOP8
LT1934/LT1934-1	36V, 250mA (I_{OUT}), Micropower Step-Down DC/DC Converter with Burst Mode Operation	V_{IN}: 3.2V to 34V, $V_{OUT(MIN)}$ = 1.25V, I_Q = 12µA, I_{SD} < 1µA, ThinSOT™ Package
LT1939	25V, 2A, 2.5MHz High Efficiency DC/DC Converter and LDO Controller	V_{IN}: 3.6V to 25V, $V_{OUT(MIN)}$ = 0.8V, I_Q = 2.5mA, I_{SD} < 10µA, 3mm × 3mm DFN10
LT3437	60V, 400mA (I_{OUT}), Micropower Step-Down DC/DC Converter with Burst Mode Operation	V_{IN}: 3.3V to 60V, $V_{OUT(MIN)}$ = 1.25V, I_Q = 100µA, I_{SD} < 1µA, 3mm × 3mm DFN10, TSSOP16E
LT3470	40V, 250mA (I_{OUT}), High Efficiency Step-Down DC/DC Converter with Burst Mode Operation	V_{IN}: 4V to 40V, $V_{OUT(MIN)}$ = 1.2V, I_Q = 26µA, I_{SD} < 1µA, 2mm × 3mm DFN8, ThinSOT
LT3685	36V with Transient Protection to 60V, 2A (I_{OUT}), 2.4MHz, High Efficiency Step-Down DC/DC Converter	V_{IN}: 3.6V to 38V, $V_{OUT(MIN)}$ = 0.78V, I_Q = 70µA, I_{SD} < 1µA, 3mm × 3mm DFN10, MSOP10E

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